

TOSHIBA Photocoupler Photorelay

TLP4197G

PBX

Telecommunication

Modem·FAX Cards, Modems In PC

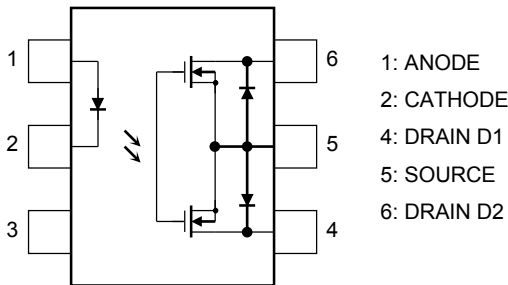
Measurement Instrumentation

The TOSHIBA TLP4197G consists of an aluminum gallium arsenide infrared emitting diode optically coupled to a photo-MOSFET in a SOP, which is suitable for surface mount assembly.

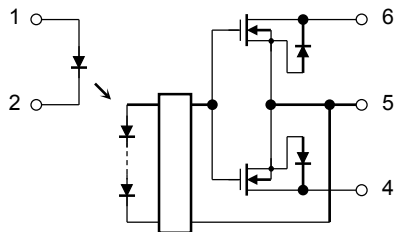
The TLP4197GA is suitable for replacement of mechanical relays in many applications which require space savings.

- 6 pin SOP (2.54SOP6): 2.1 mm high, 2.54 mm pitch
- 1-form-B
- Peak off-state voltage: 350 V (min)
- Trigger LED current: 3 mA (max)
- On-state current: 120 mA (max)
- On-state resistance: 25 Ω (max)
- Isolation voltage: 1500 Vrms (min)
- UL approved: UL1577, File No.E67349

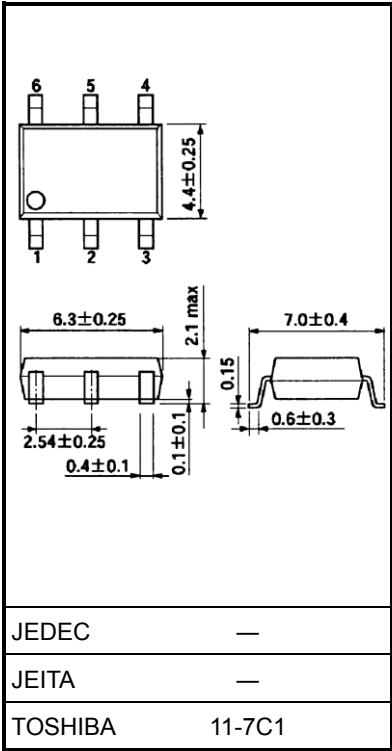
Pin Configuration (top view)



Schematic



Unit: mm



Weight: 0.13 g (typ.)

Start of commercial production  
2001-05

## Absolute Maximum Ratings (Ta = 25°C)

Characteristics			Symbol	Rating	Unit
LED	Forward current		I <sub>F</sub>	50	mA
	Forward current derating (Ta ≥ 25°C)		ΔI <sub>F</sub> /°C	-0.5	mA/°C
	Peak forward current (100 μs pulse, 100 pps)		I <sub>FP</sub>	1	A
	Reverse voltage		V <sub>R</sub>	5	V
	Diode power dissipation		P <sub>D</sub>	50	mW
	Diode power dissipation derating (Ta ≥ 25°C)		ΔP <sub>D</sub> /°C	-0.5	mW/°C
	Junction temperature		T <sub>j</sub>	125	°C
Detector	Off-state output terminal voltage		V <sub>OFF</sub>	350	V
	On-state current	A connection	I <sub>ON</sub>	120	mA
		B connection		120	
		C connection		240	
	On-state current derating (Ta ≥ 25°C)	A connection	ΔI <sub>ON</sub> /°C	-1.2	mA/°C
		B connection		-1.2	
		C connection		-2.4	
	Output power dissipation	A connection	P <sub>O</sub>	360	mW
		B connection		201	
		C connection		403	
	Output power dissipation derating (Ta ≥ 25°C)	A connection	ΔP <sub>O</sub> /°C	-3.6	mW /°C
		B connection		-2.0	
		C connection		-4.0	
Junction temperature		T <sub>j</sub>	125	°C	
Operating temperature range		T <sub>opr</sub>	-40 to 85	°C	
Storage temperature range		T <sub>stg</sub>	-55 to 125	°C	
Lead soldering temperature (10 s)		T <sub>sol</sub>	260	°C	
Isolation voltage (AC, 1 minute, R.H. ≤ 60%) (Note 1)		BV <sub>S</sub>	1500	V <sub>rms</sub>	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

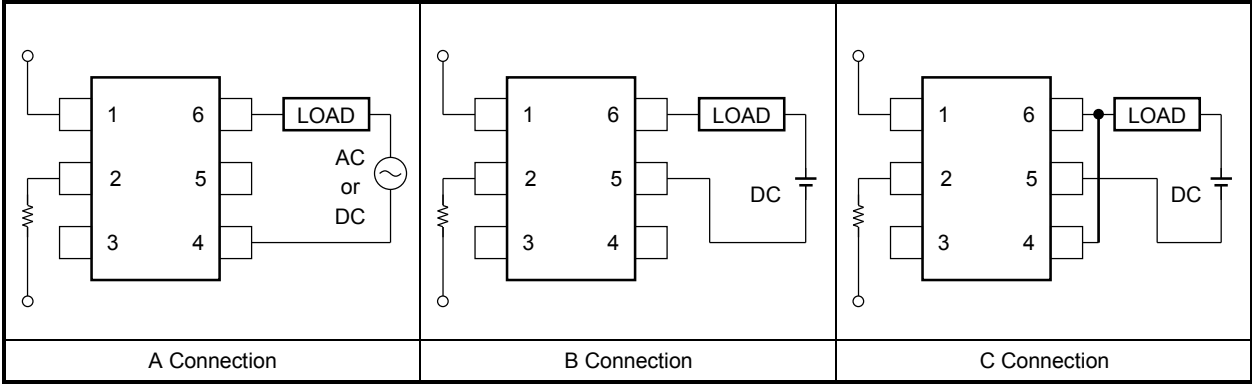
Note 1: Device considered a two-terminal device: LED side pins shorted together, and DETECTOR side pins and 6 shorted together.

## Recommended Operating Conditions

Characteristics	Symbol	Min	Typ.	Max	Unit
Supply voltage	V <sub>DD</sub>	—	—	280	V
Forward current	I <sub>F</sub>	5	—	25	mA
On-state current	I <sub>ON</sub>	—	—	120	mA
Operating temperature	T <sub>opr</sub>	-20	—	65	°C

Note: Recommended operating conditions are given as a design guideline to obtain expected performance of the device. Additionally, each item is an independent guideline respectively. In developing designs using this product, please confirm specified characteristics shown in this document.

Circuit Connections



## Electrical Characteristics (Ta = 25°C)

Characteristics		Symbol	Test Condition	Min	Typ.	Max	Unit
LED	Forward voltage	V <sub>F</sub>	I <sub>F</sub> = 10 mA	1.0	1.15	1.3	V
	Reverse current	I <sub>R</sub>	V <sub>R</sub> = 5 V	—	—	10	μA
	Capacitance	C <sub>T</sub>	V <sub>F</sub> = 0 V, f = 1 MHz	—	30	—	pF
Detector	Off-state current	I <sub>OFF</sub>	V <sub>OFF</sub> = 350 V, I <sub>F</sub> = 5 mA	—	—	1	μA
	Capacitance	C <sub>OFF</sub>	V = 0 V, f = 1 MHz, I <sub>F</sub> = 5 mA	—	65	—	pF

## Coupled Electrical Characteristics (Ta = 25°C)

Characteristics		Symbol	Test Condition	Min	Typ.	Max	Unit
Trigger LED current		I <sub>FC</sub>	I <sub>OFF</sub> = 10 μA	—	1	3	mA
Return LED current		I <sub>FT</sub>	I <sub>ON</sub> = 120 mA	0.1	—	—	mA
On-state resistance	A connection	R <sub>ON</sub>	I <sub>ON</sub> = 120 mA	—	15	25	Ω
	B connection		I <sub>ON</sub> = 120 mA	—	8	14	
	C connection		I <sub>ON</sub> = 240 mA	—	4	—	

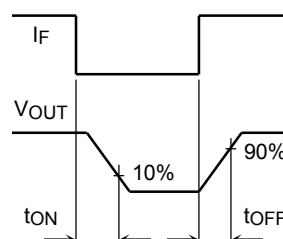
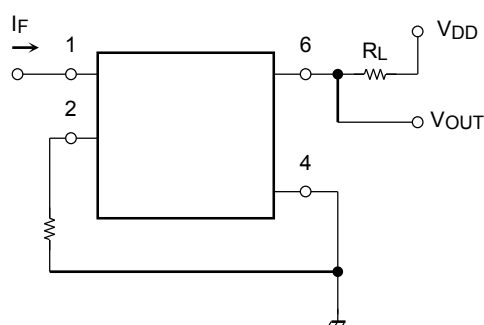
## Isolation Characteristics (Ta = 25°C)

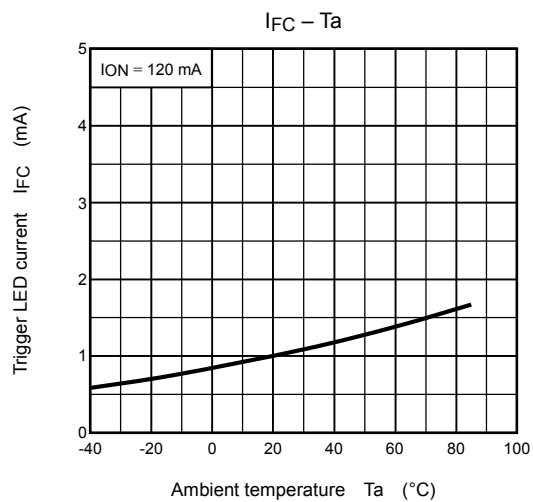
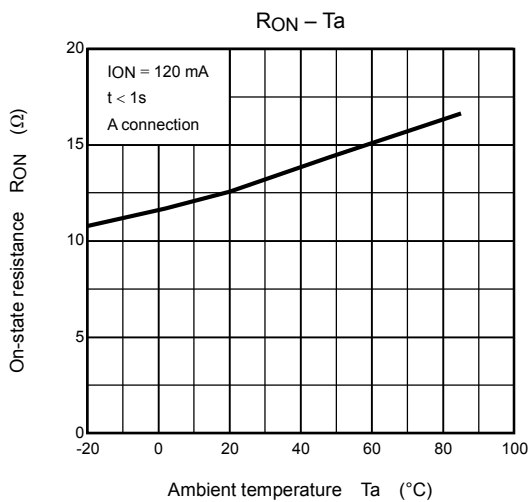
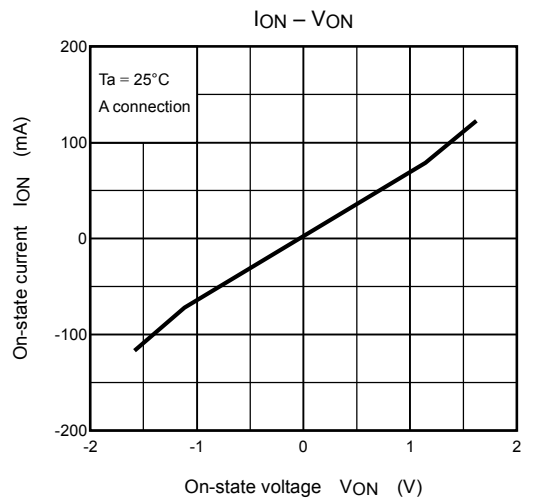
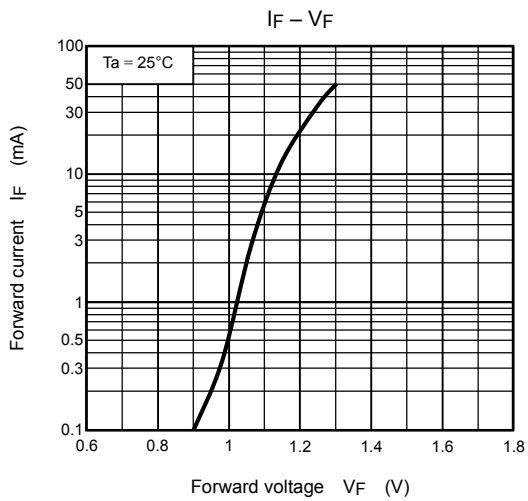
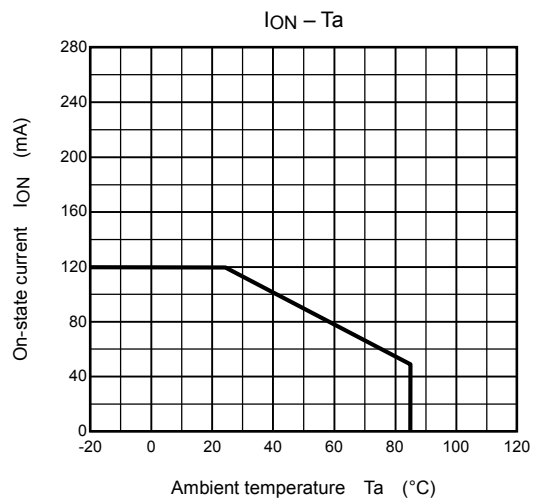
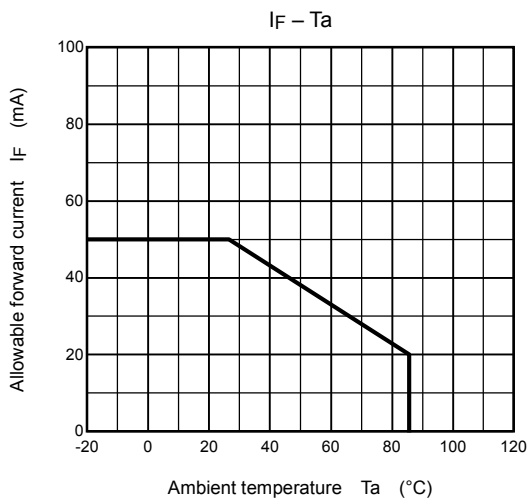
Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Capacitance input to output	C <sub>S</sub>	V <sub>S</sub> = 0 V, f = 1 MHz	—	0.8	—	pF
Isolation resistance	R <sub>S</sub>	V <sub>S</sub> = 500 V, R.H. ≤ 60%	5 × 10 <sup>10</sup>	10 <sup>14</sup>	—	Ω
Isolation voltage	BV <sub>S</sub>	AC, 1 minute	1500	—	—	V <sub>rms</sub>
		AC, 1 second, in oil	—	3000	—	
		DC, 1 minute, in oil	—	3000	—	V <sub>dc</sub>

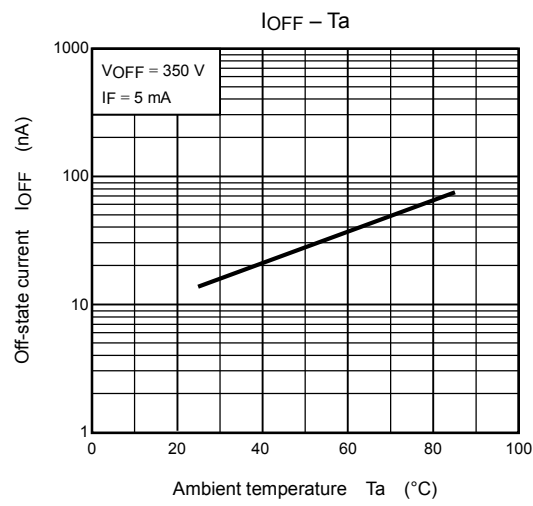
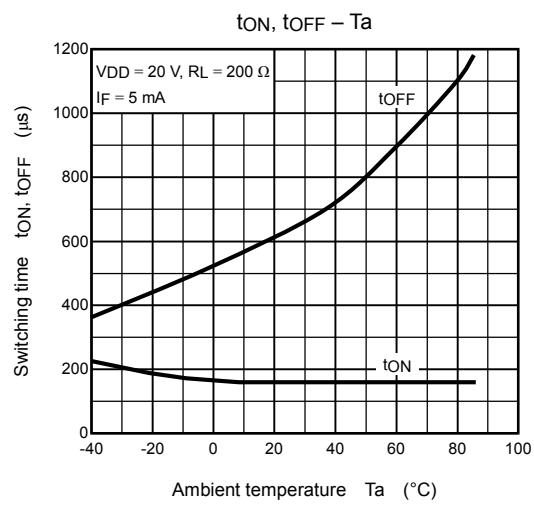
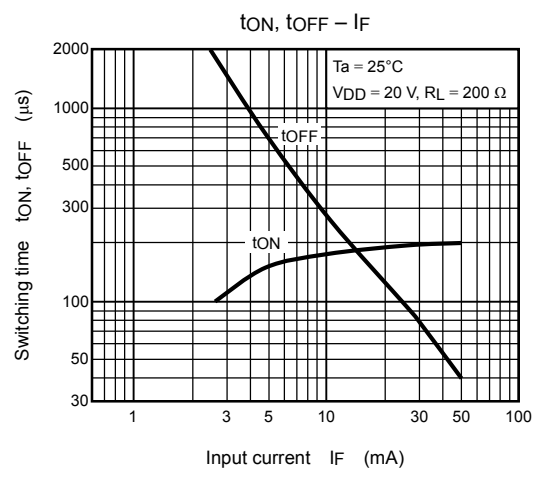
## Switching Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Turn-on time	t <sub>ON</sub>	R <sub>L</sub> = 200 Ω (Note 2)	—	—	1	ms
Turn-off time	t <sub>OFF</sub>	V <sub>DD</sub> = 20 V, I <sub>F</sub> = 5 mA	—	—	3	ms

Note 2: Switching time test circuit







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